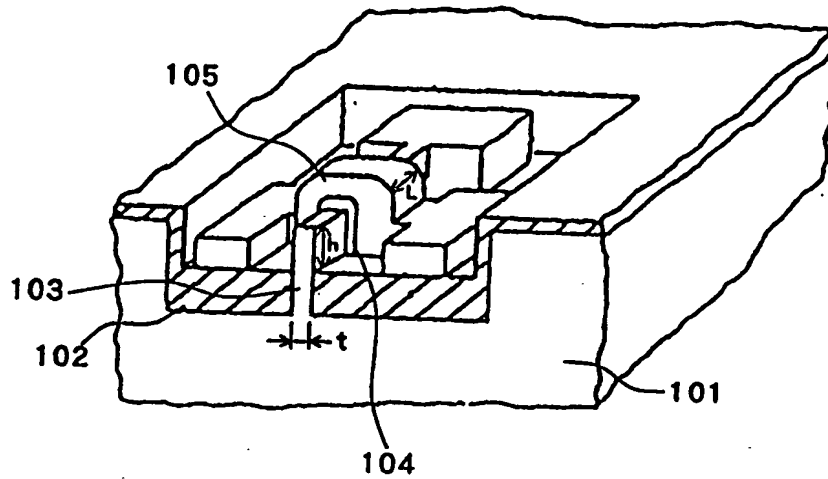


Fig. 1

(a)



(b)

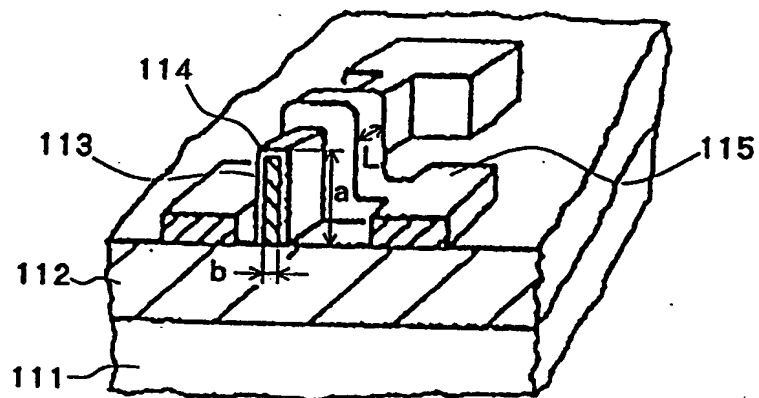


Fig. 2

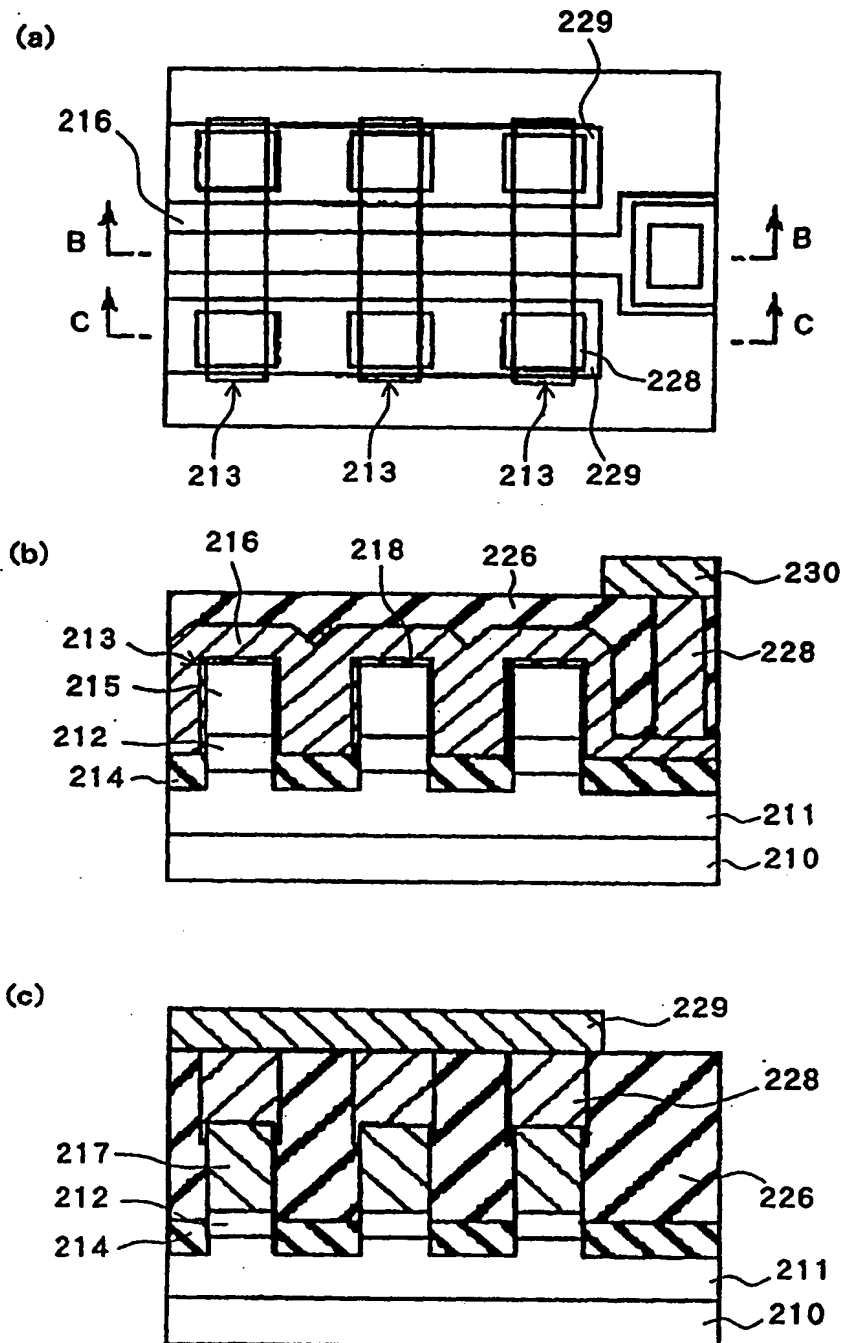
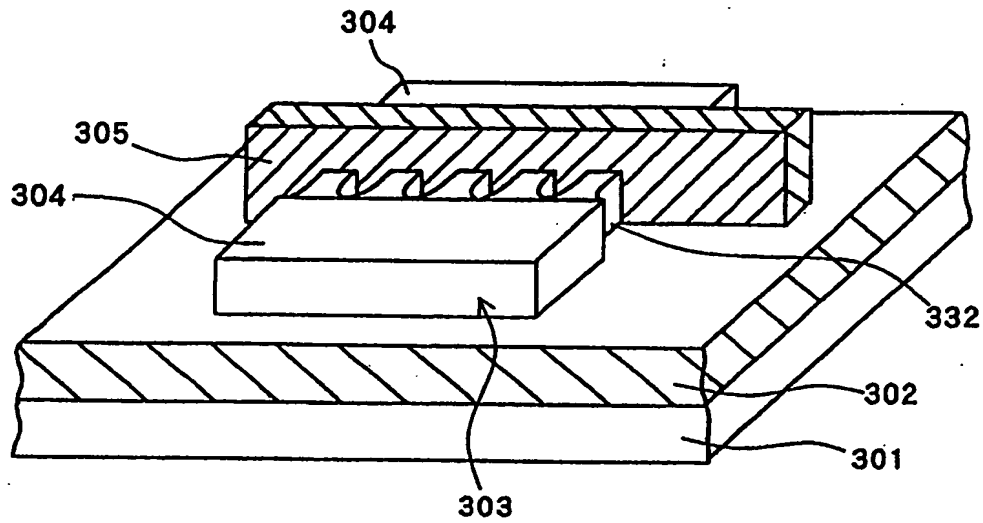


Fig. 3

(a)



(b)

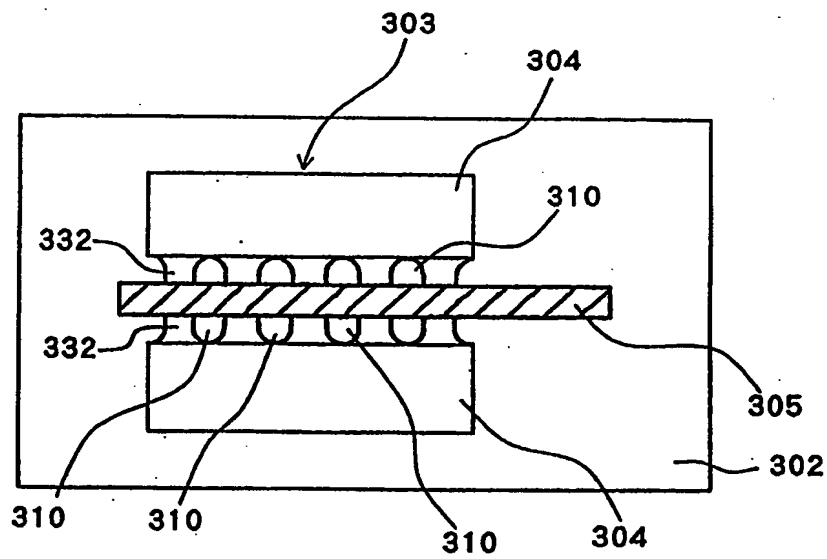
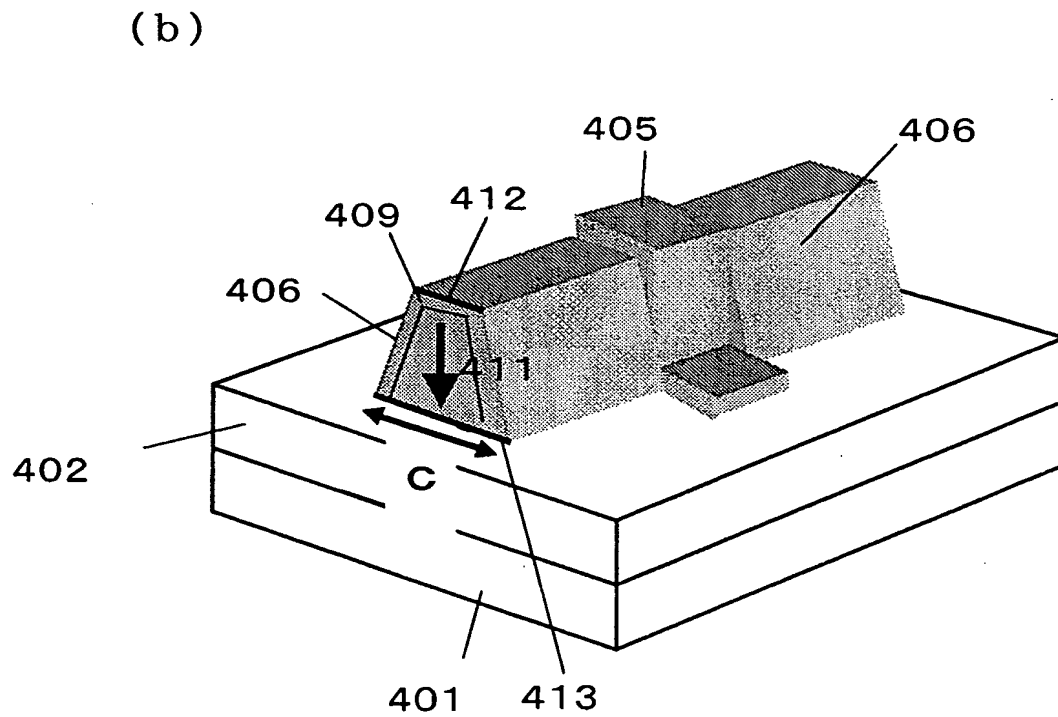
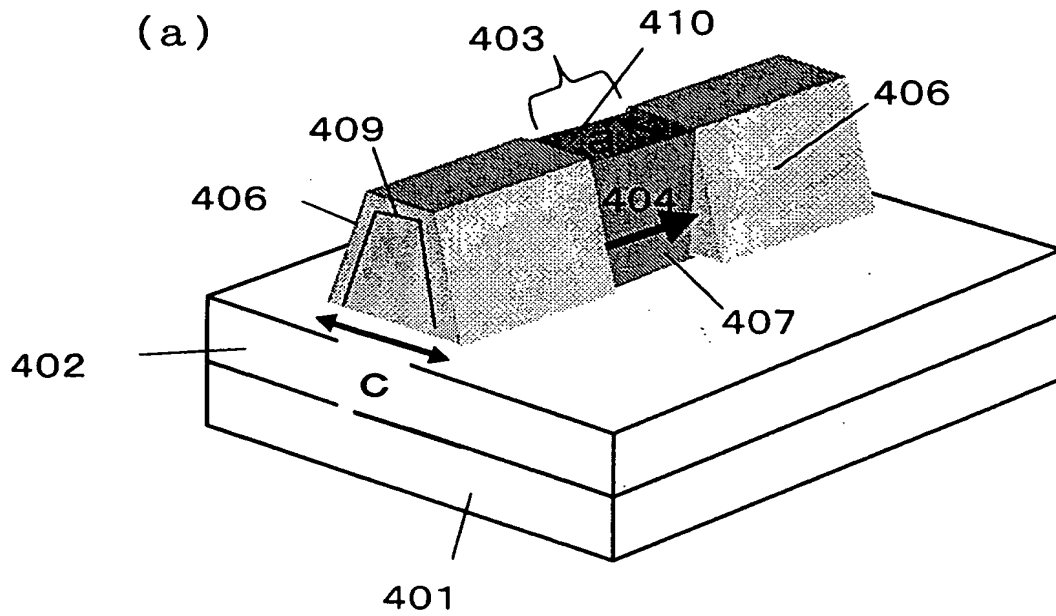


Fig. 4



Title: SEMICONDUCTOR DEVICE
AND MANUFACTURING PROCESS
THEREFOR

Inventor(s): Koichi TERASHIMA, et al.
DOCKET NO.: 040373-0382

Fig. 5

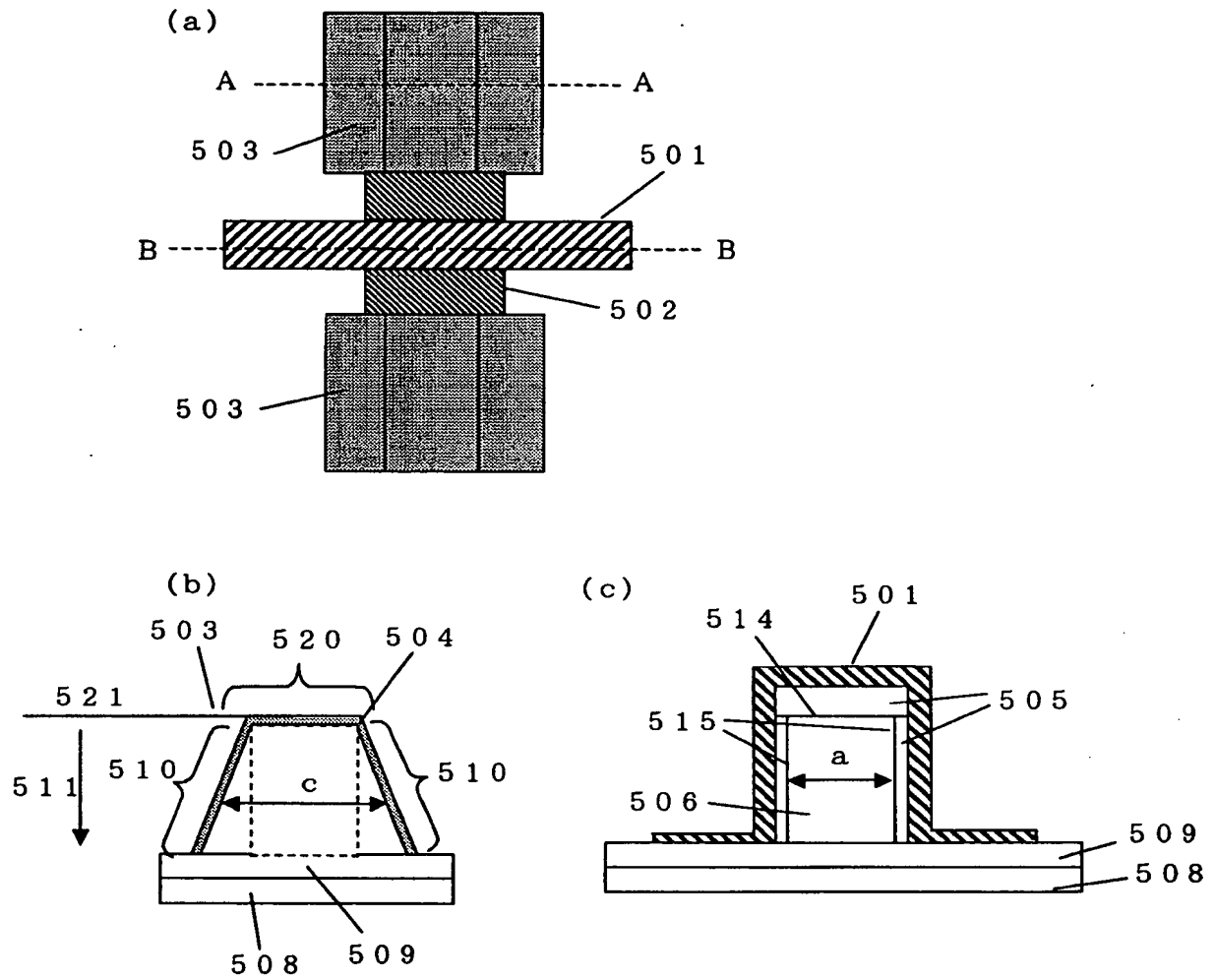


Fig. 6

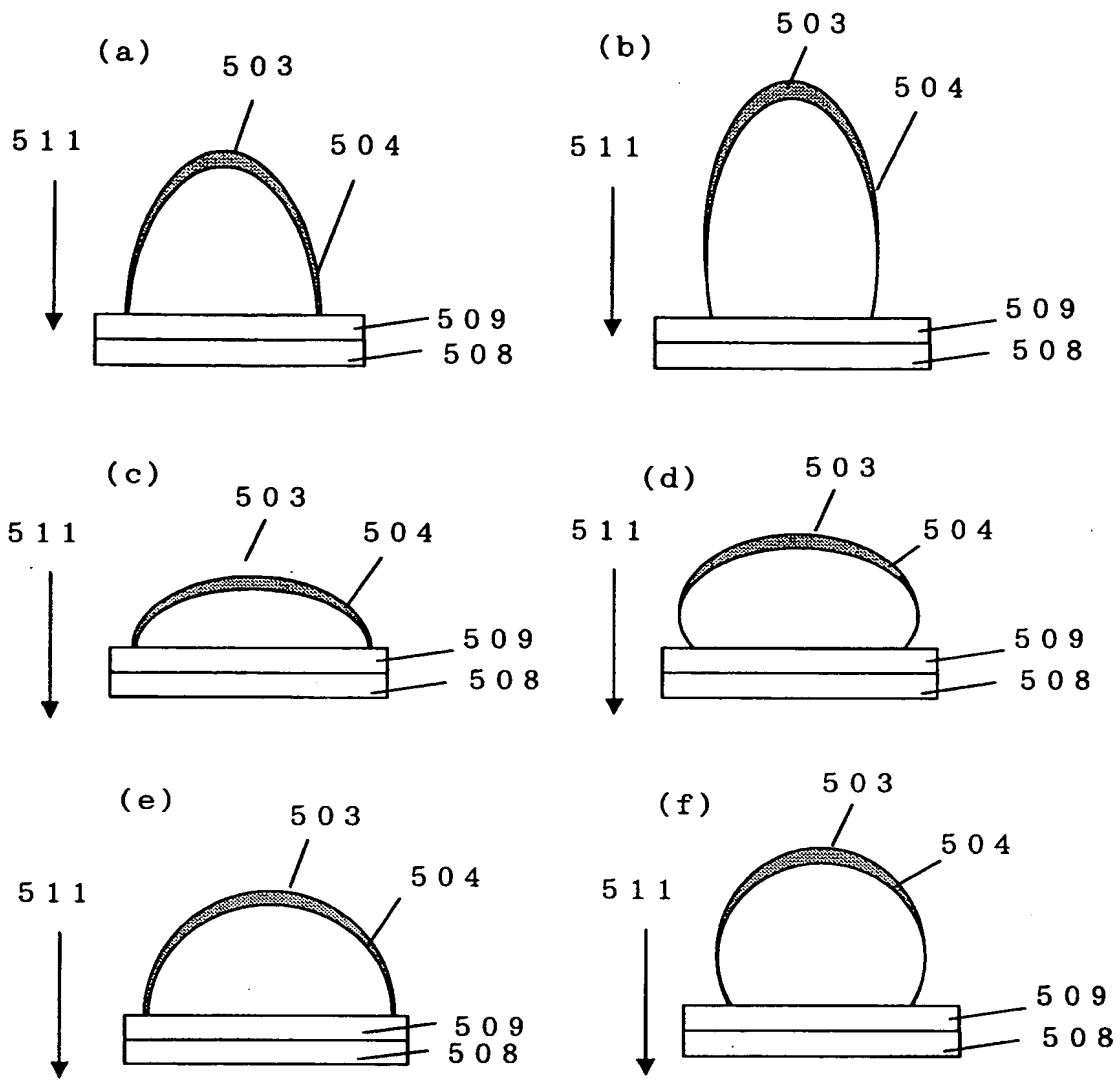


Fig. 7

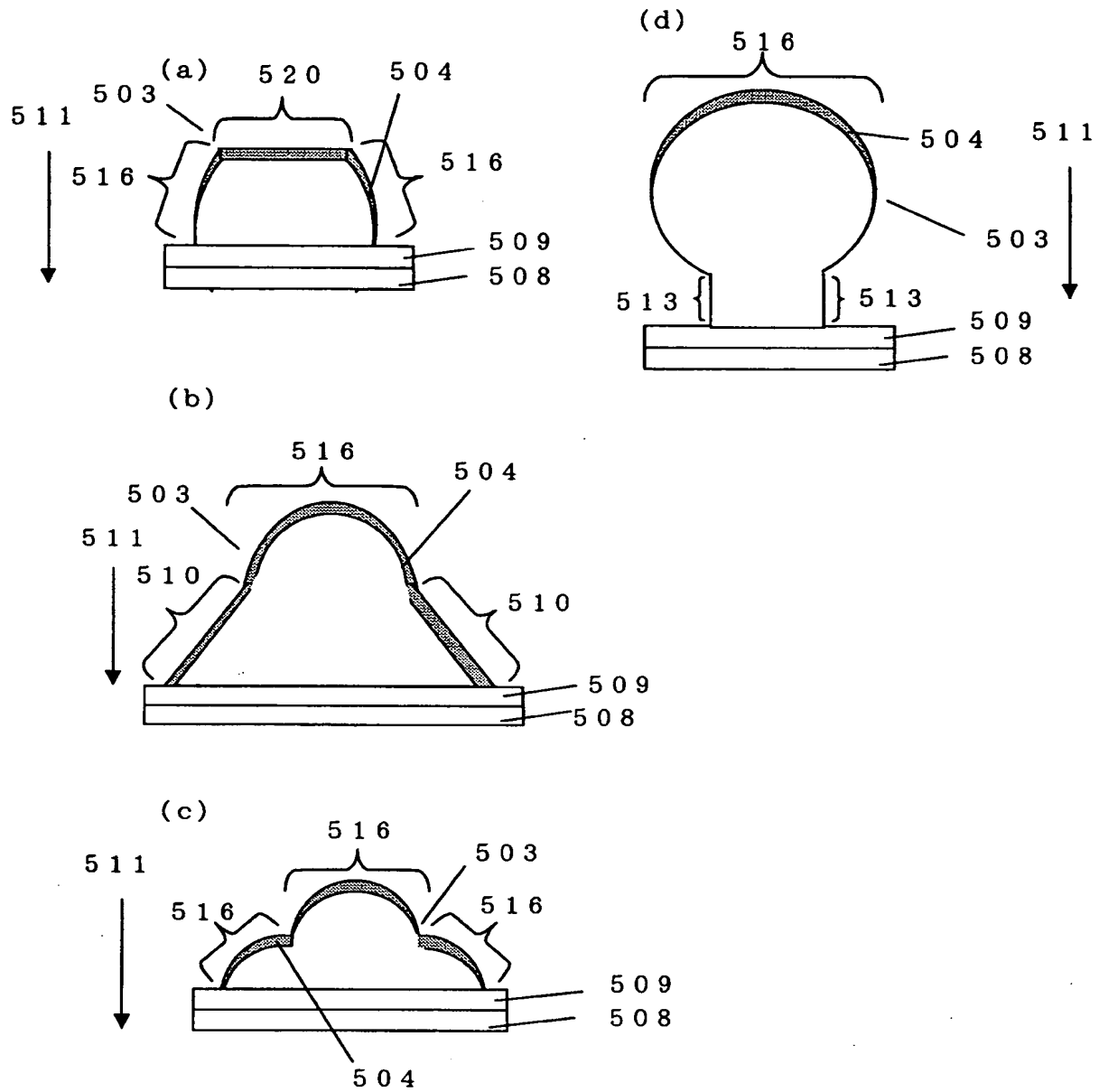


Fig. 8

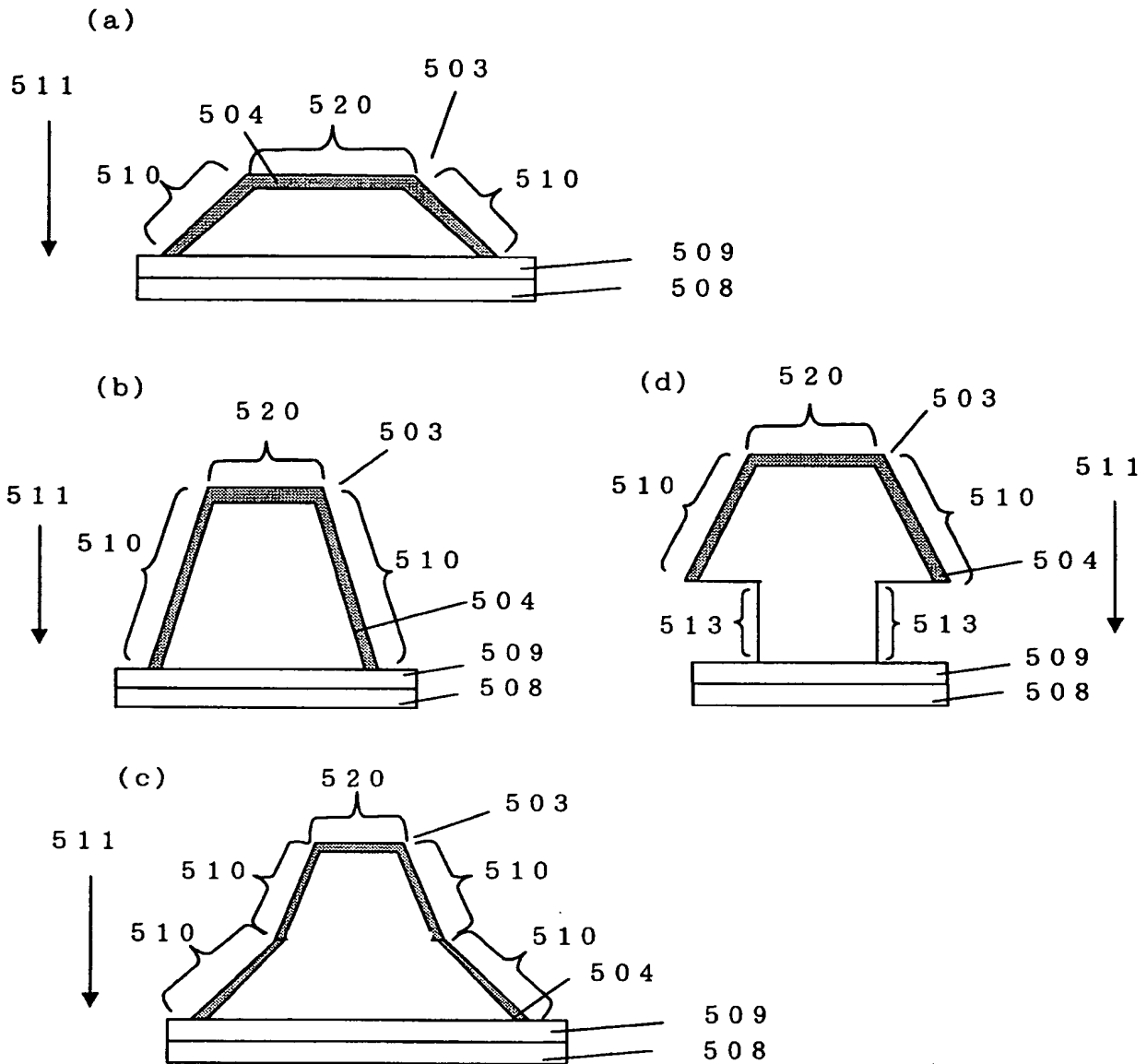


Fig. 9

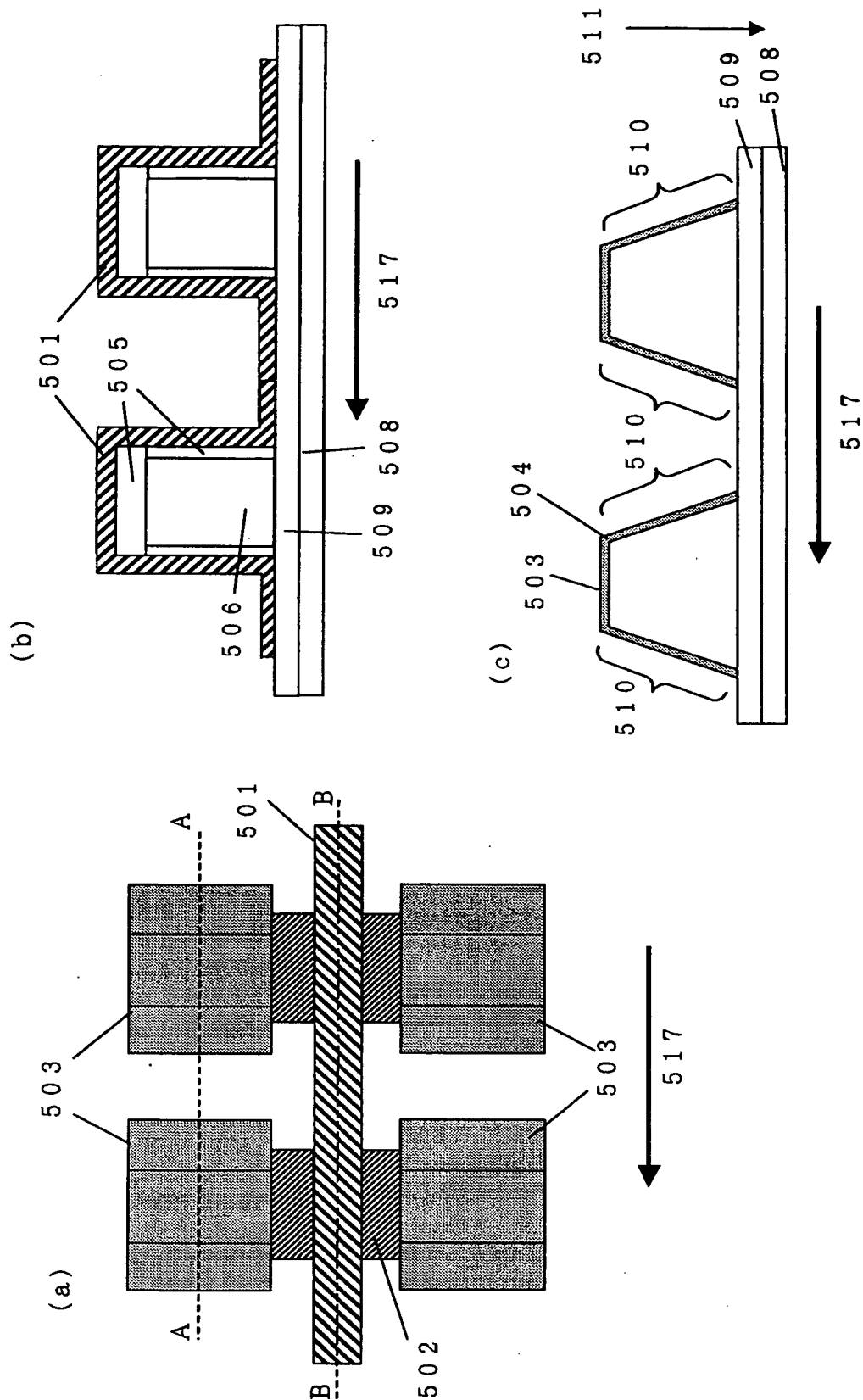


Fig. 10

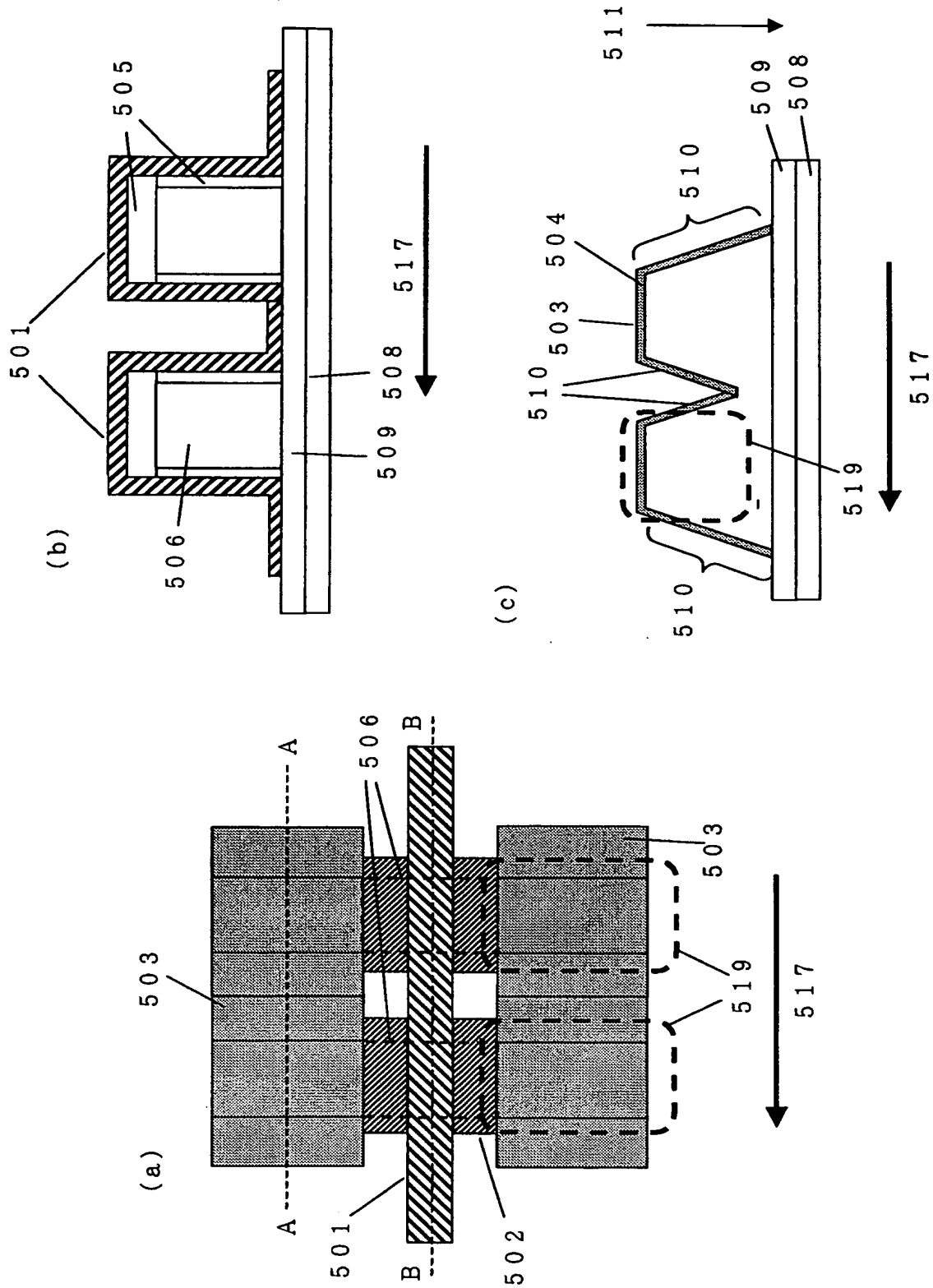


Fig. 11

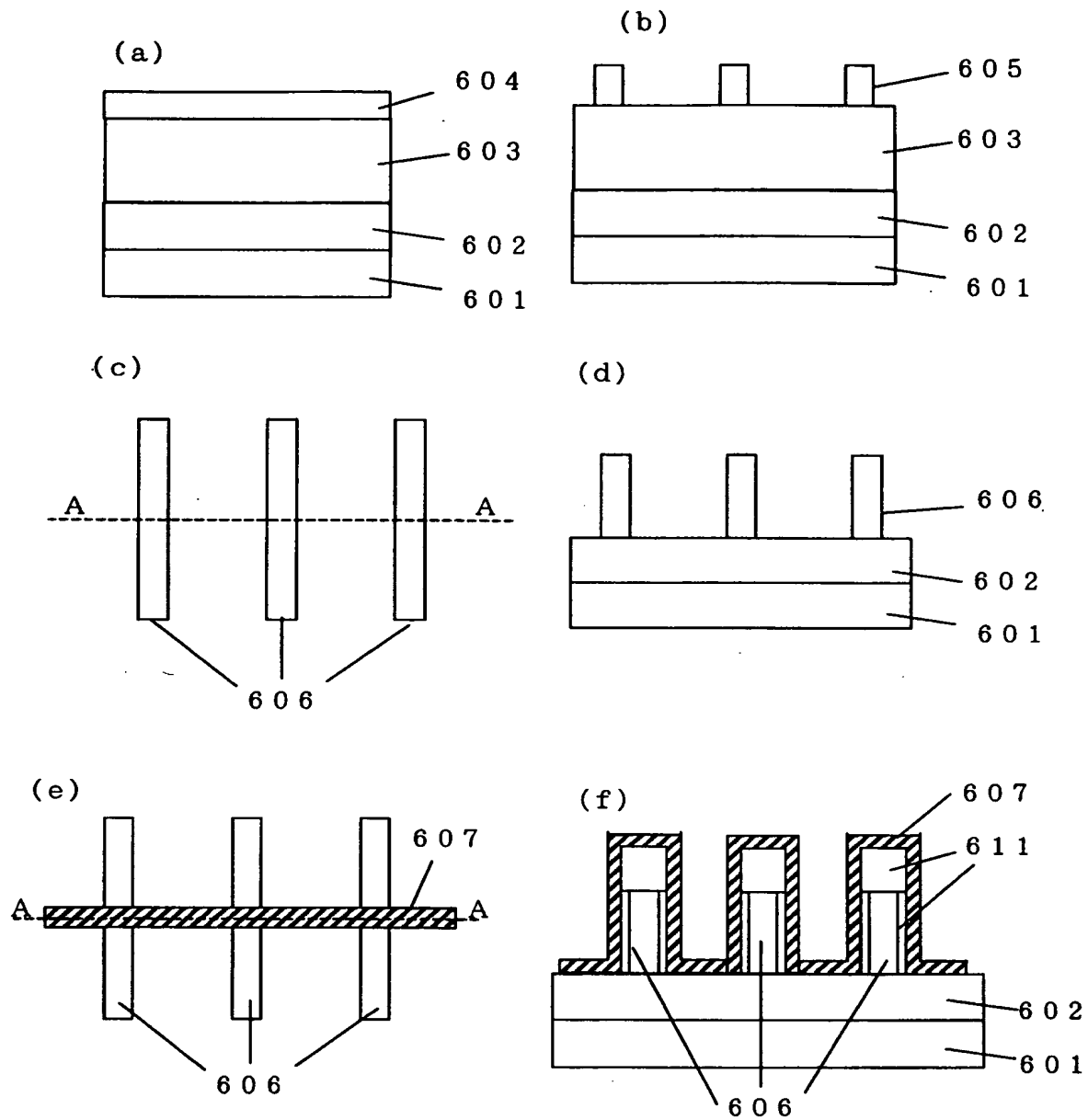


Fig. 12

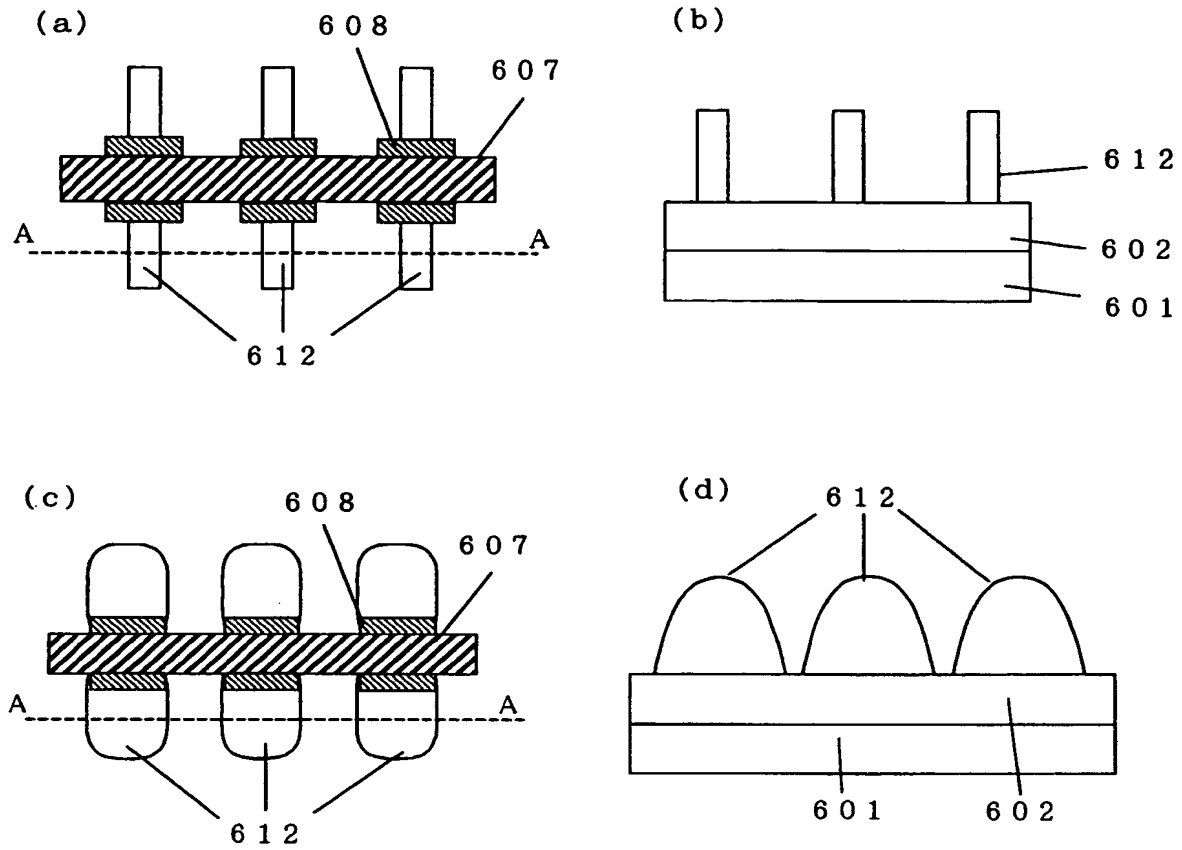


Fig. 13

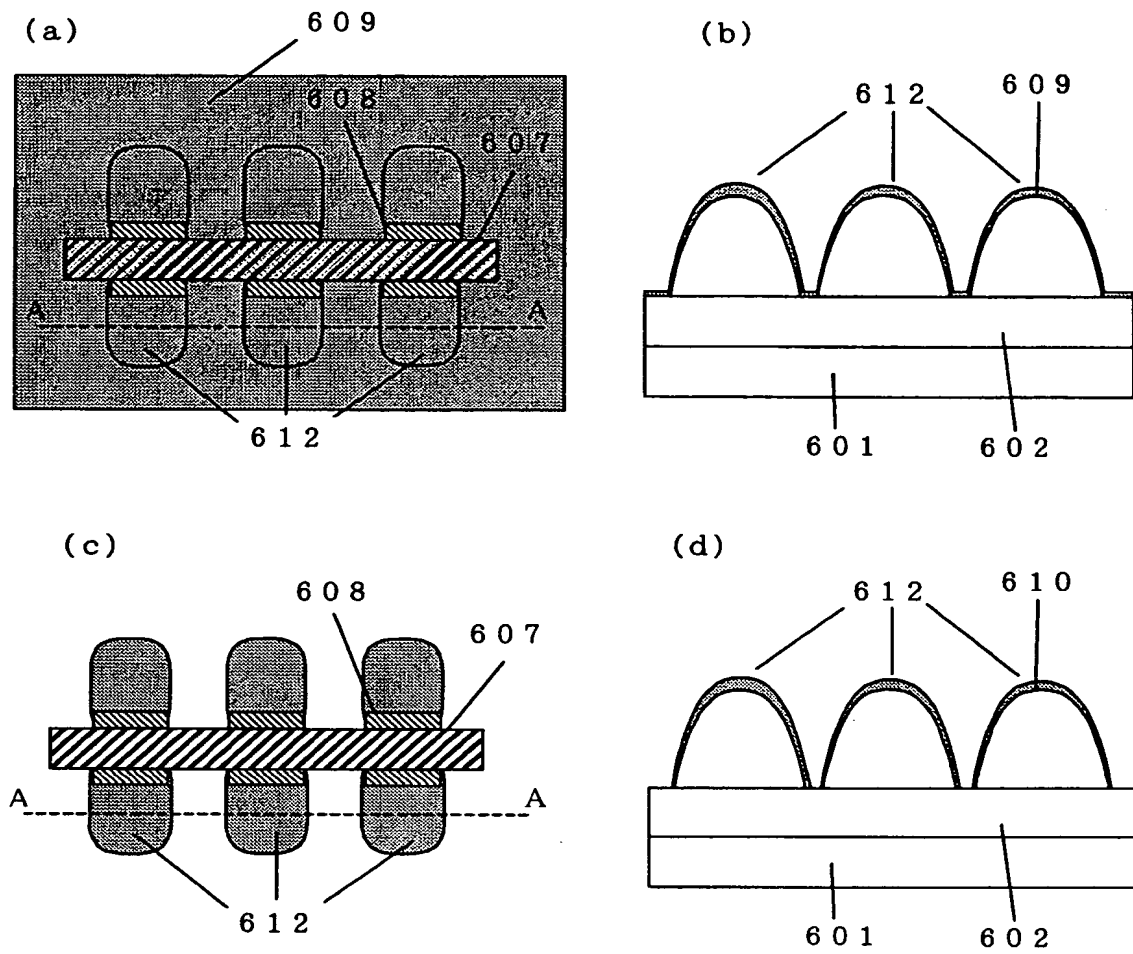


Fig. 14

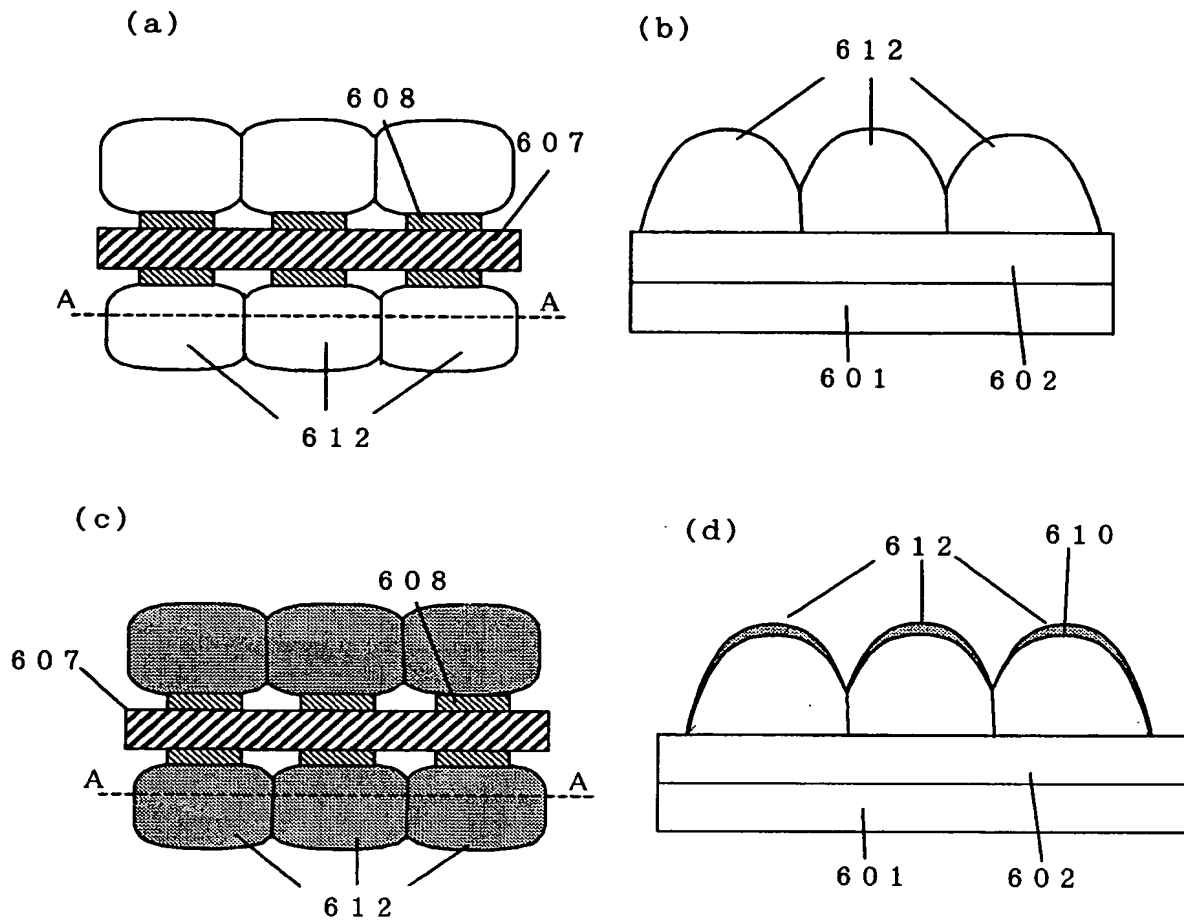


Fig. 15

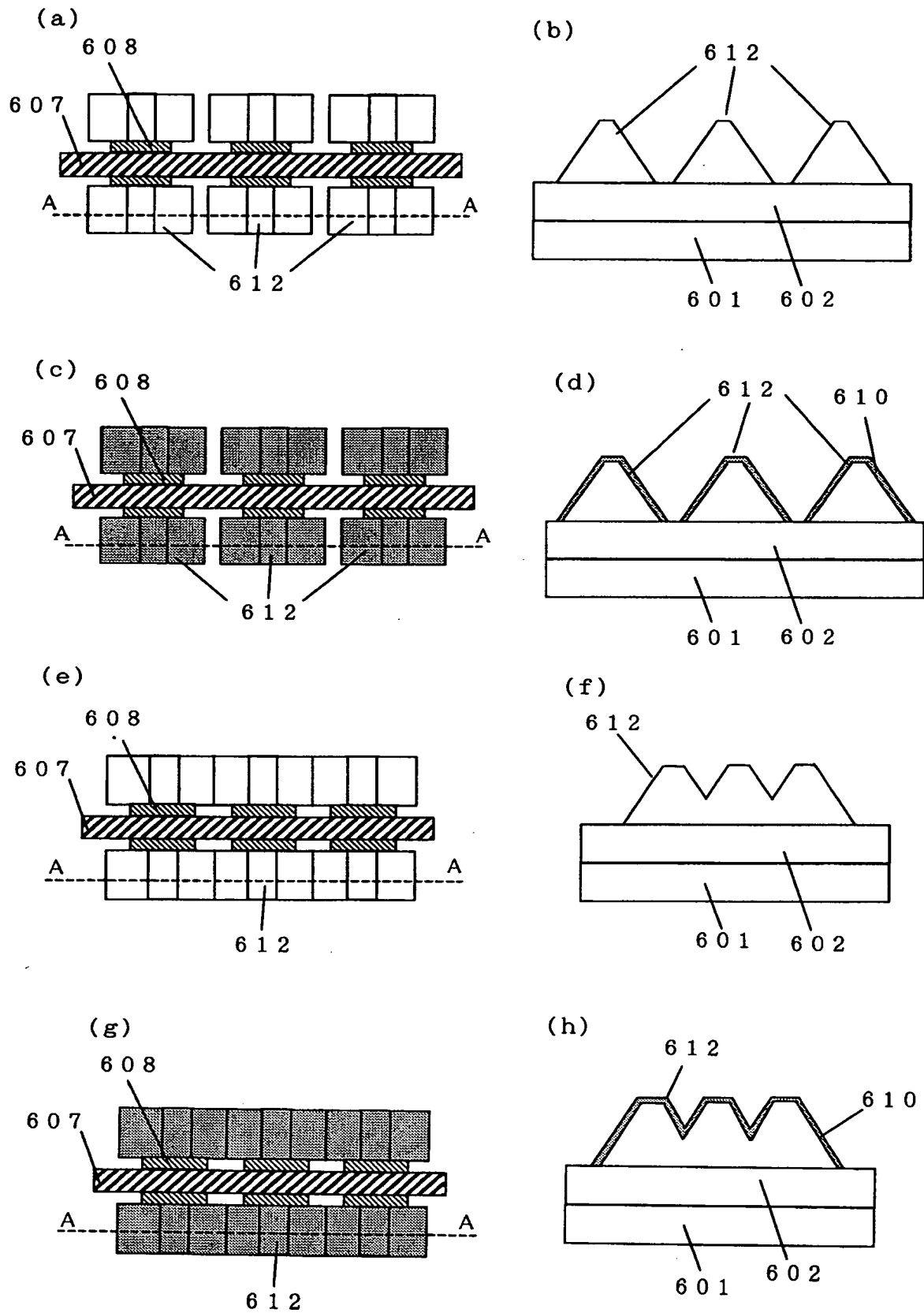


Fig. 16

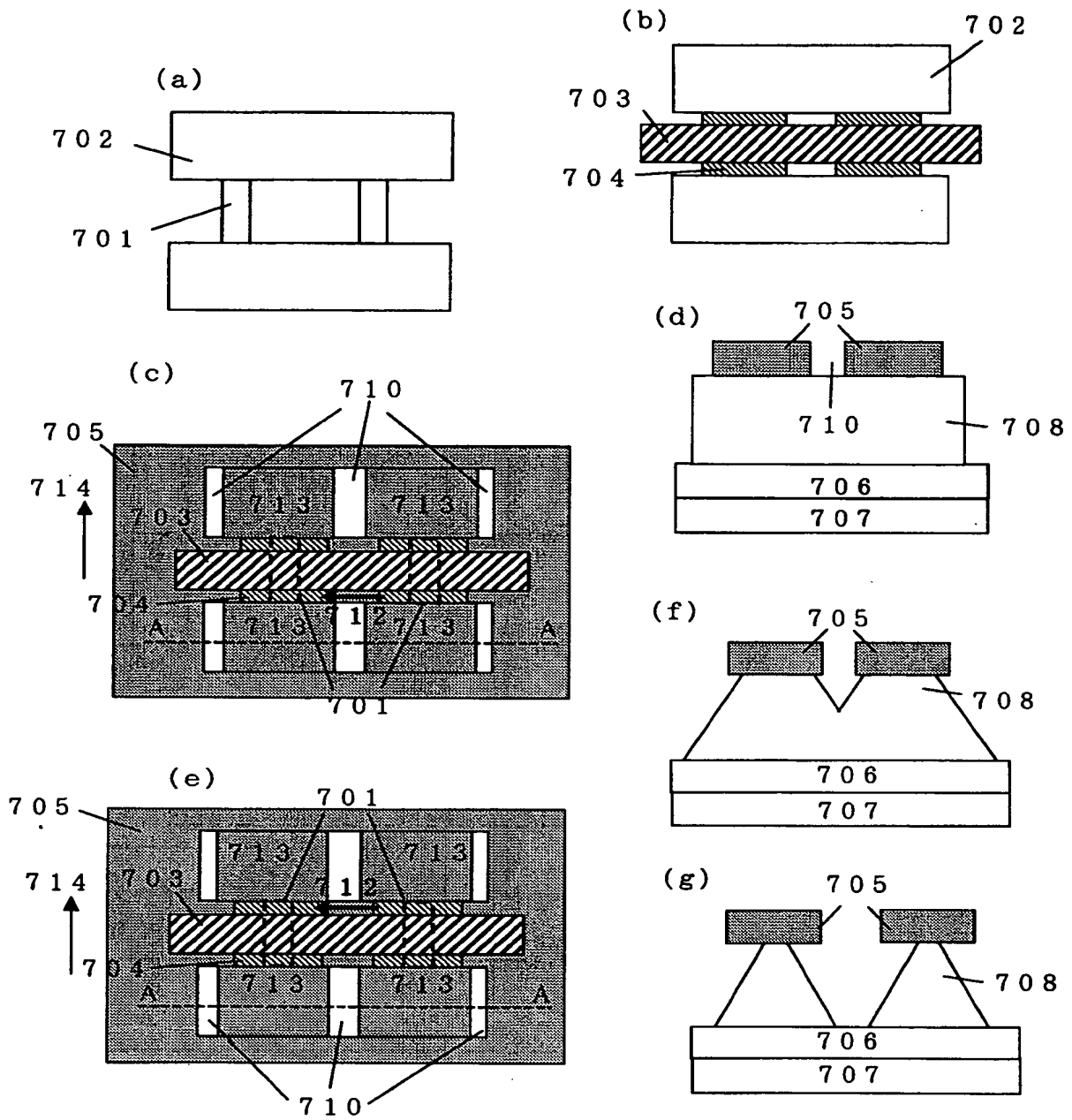


Fig. 17

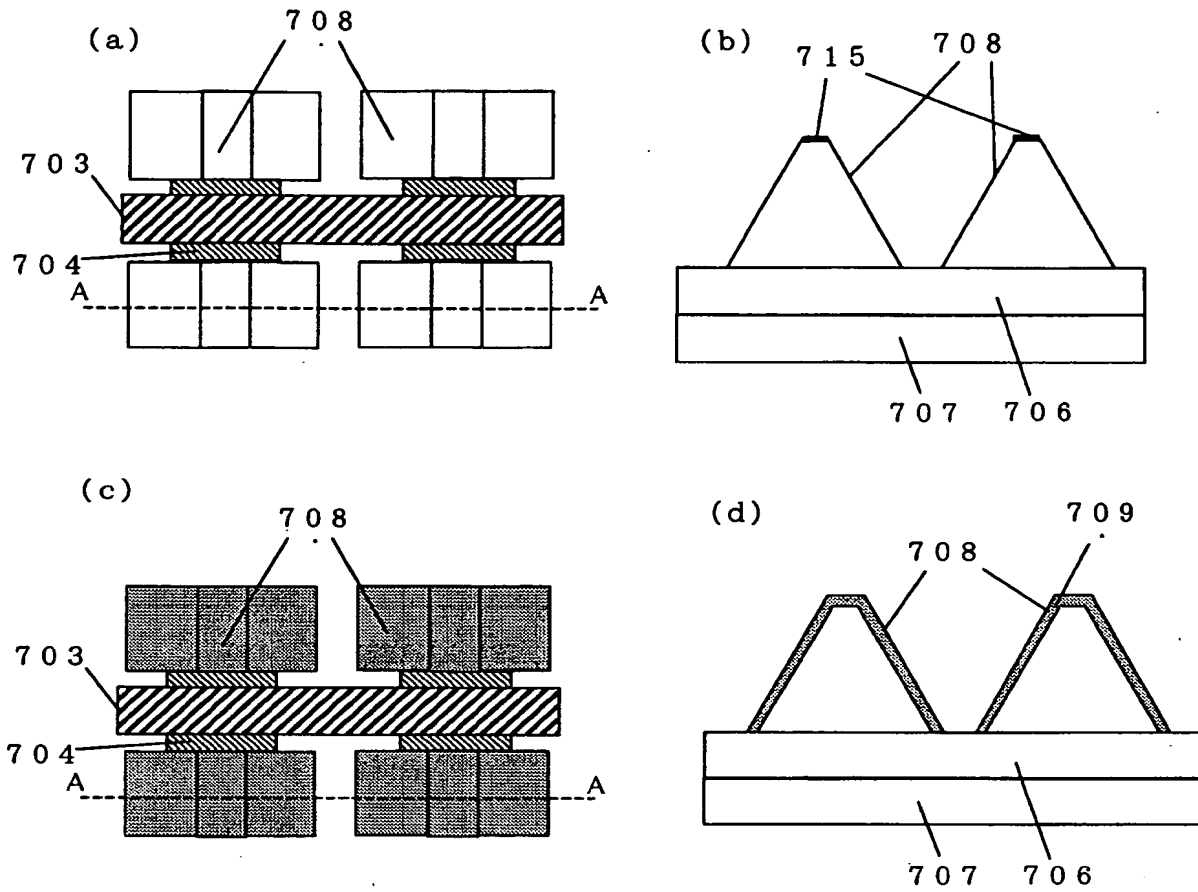


Fig. 18

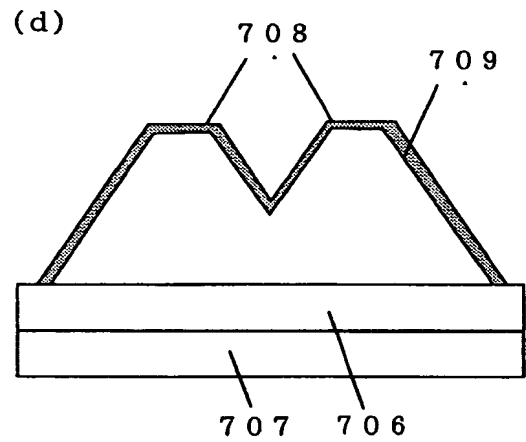
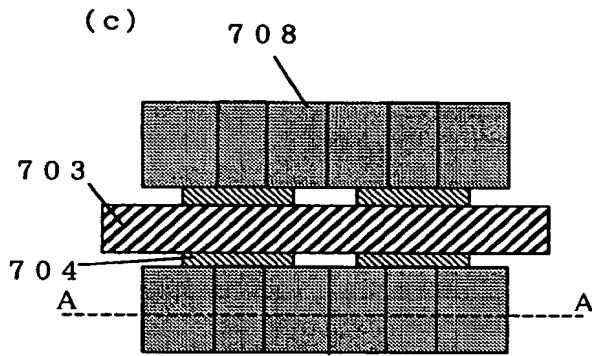
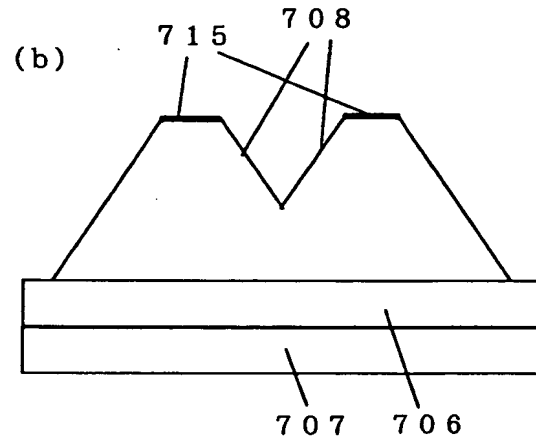
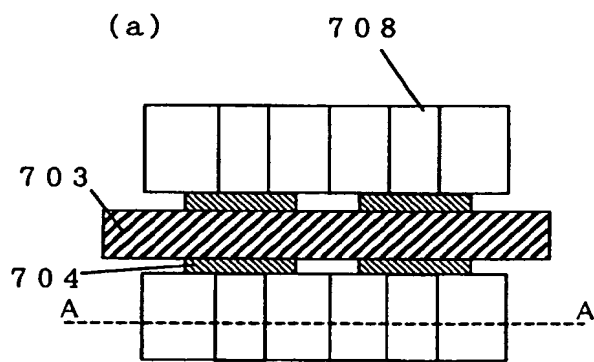


Fig. 19

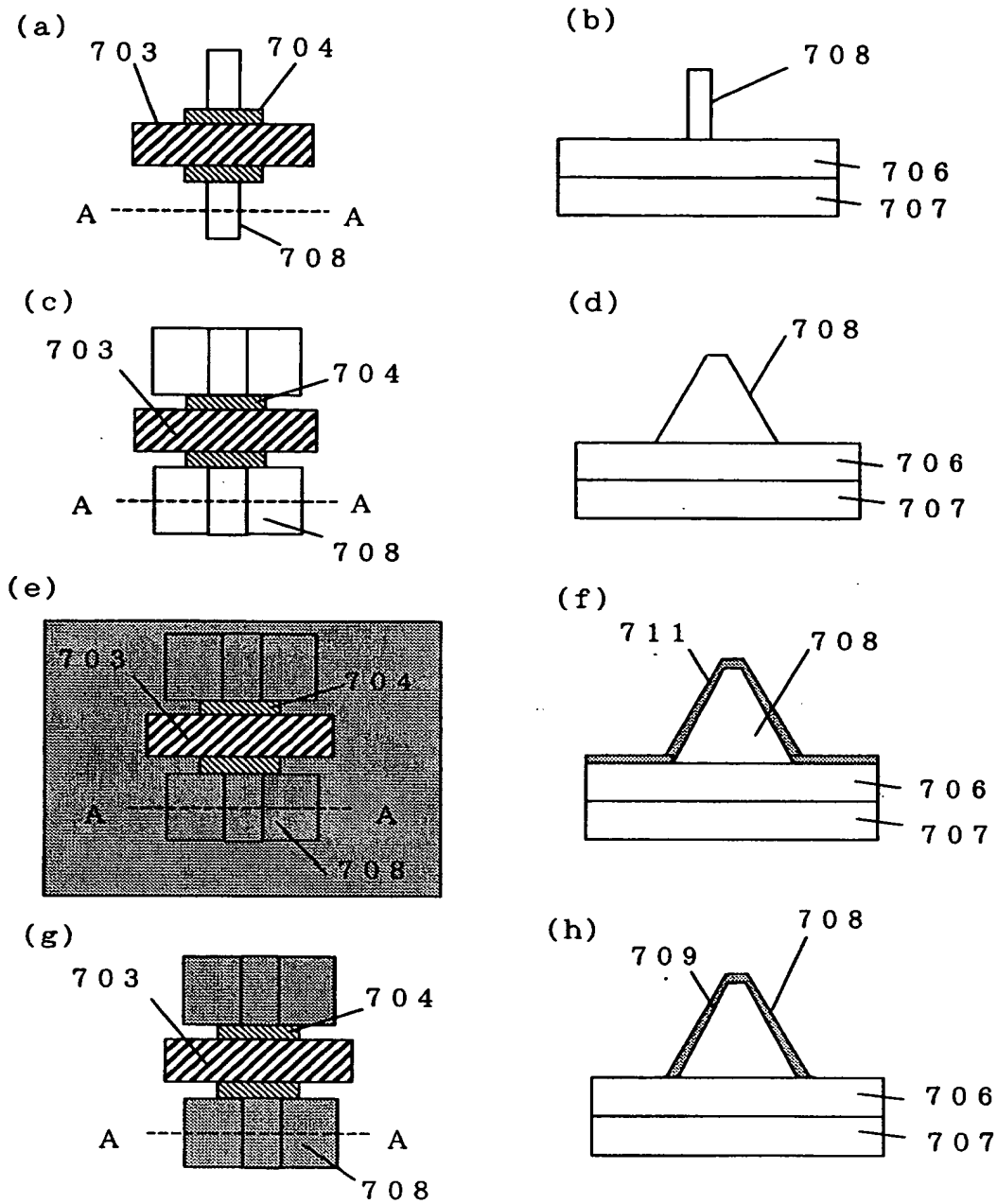
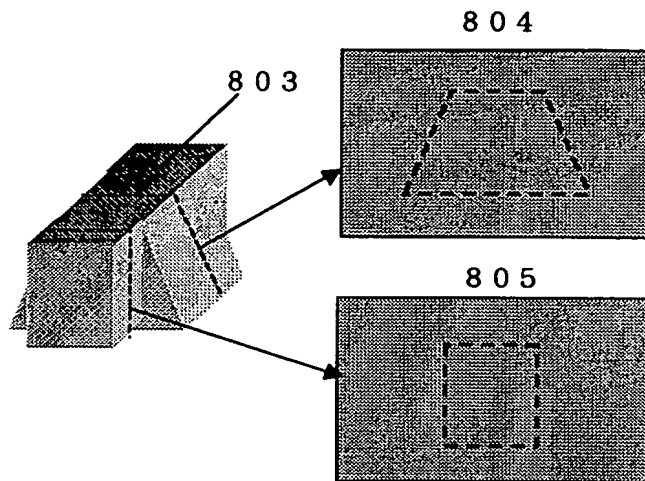


Fig. 20

(a)



(b)

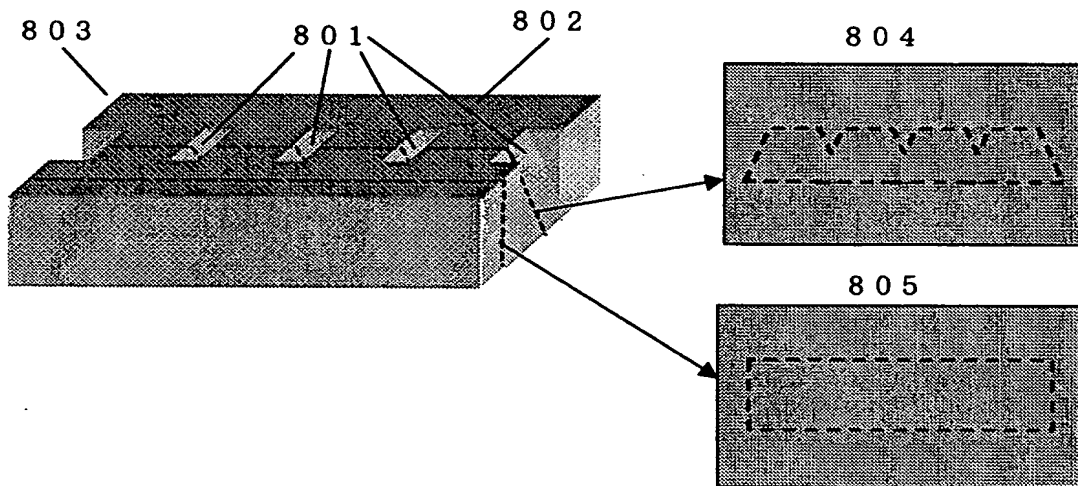


Fig. 21

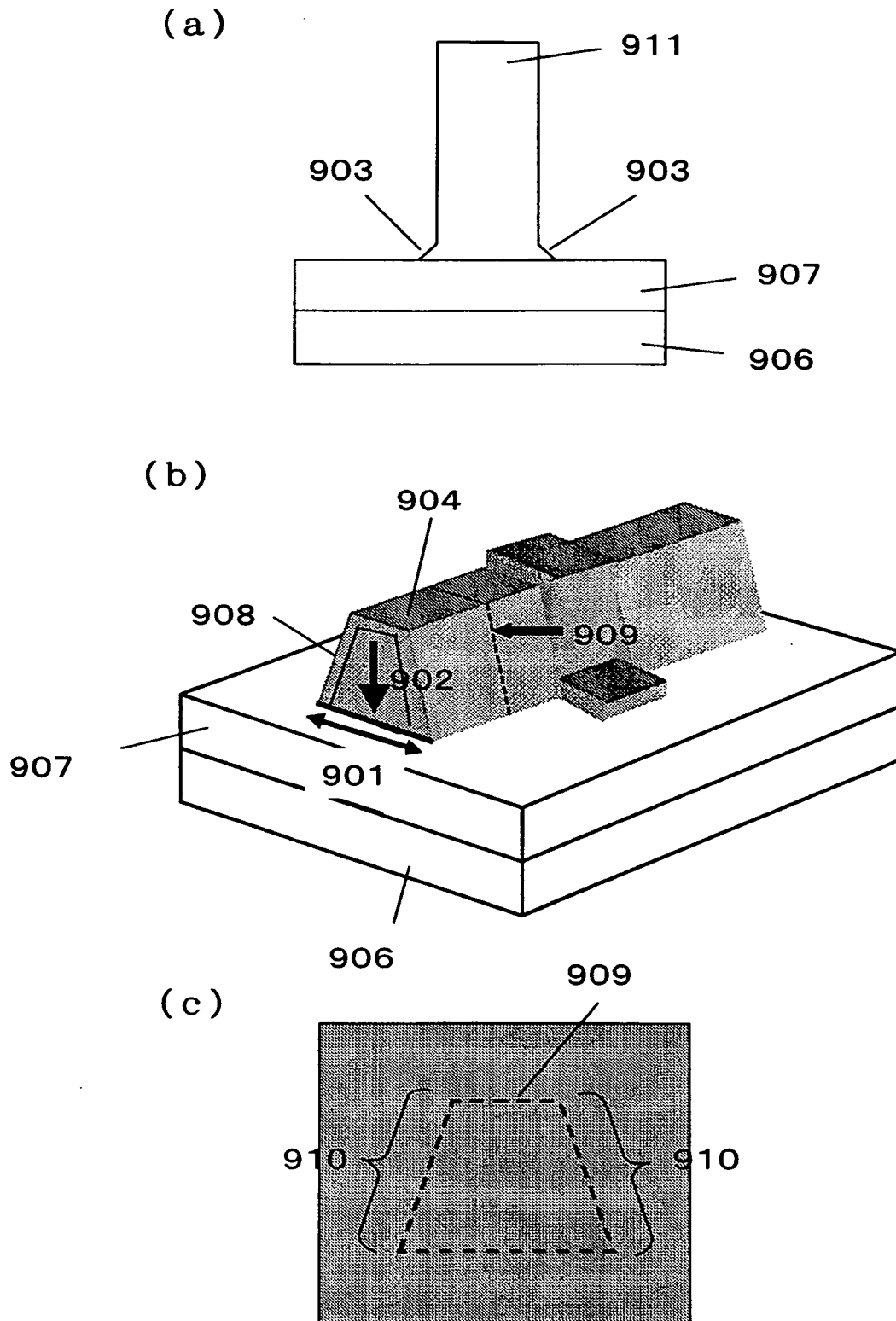


Fig. 22

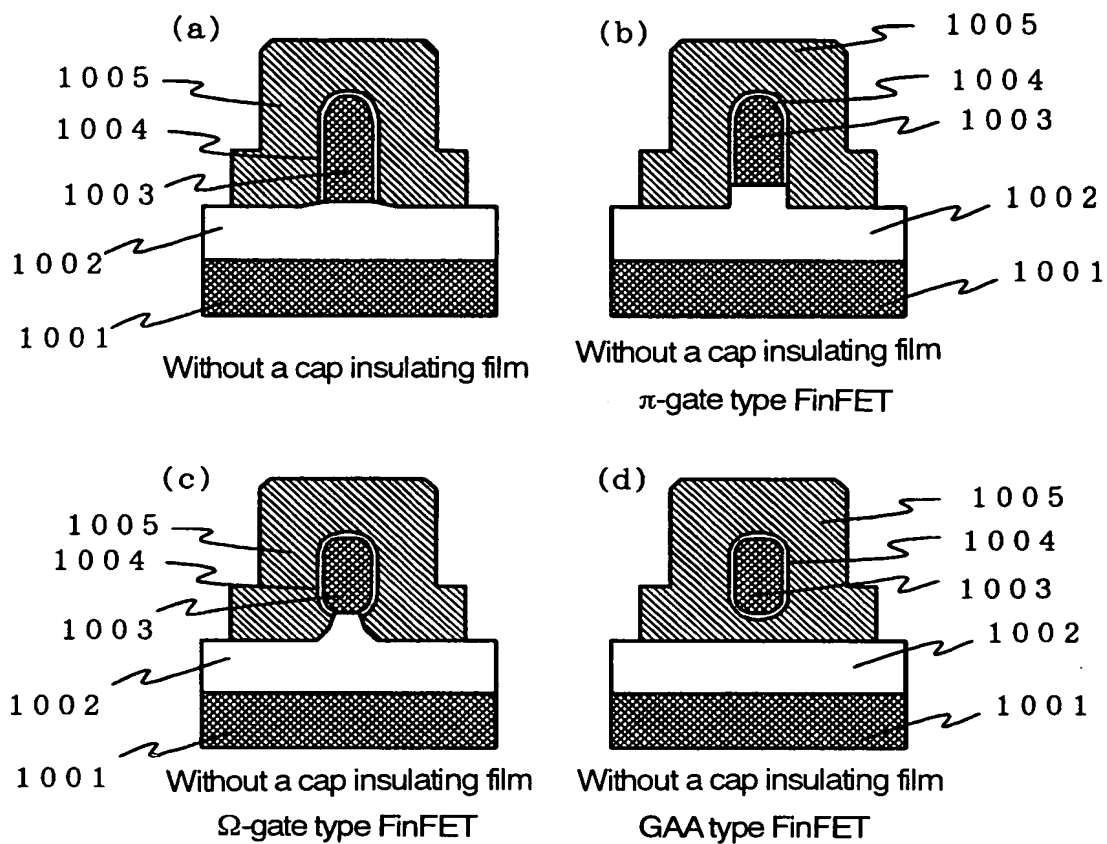


Fig. 23

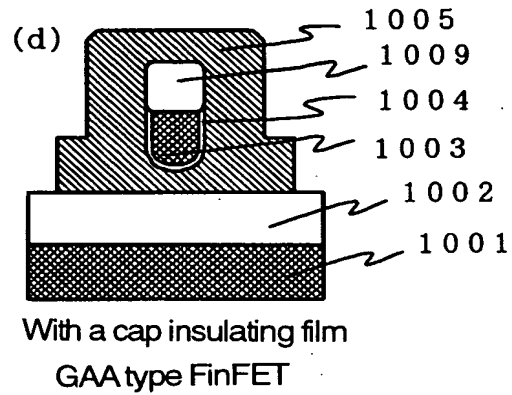
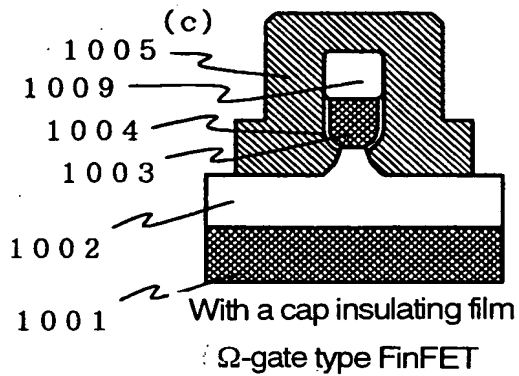
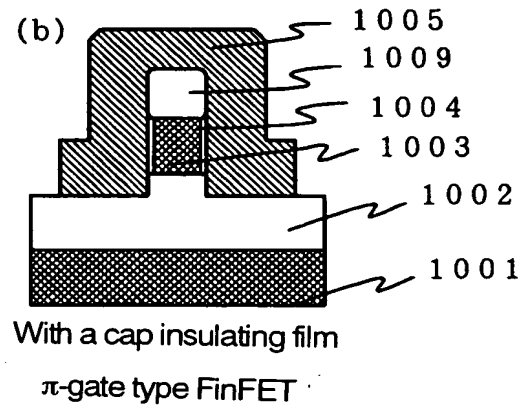
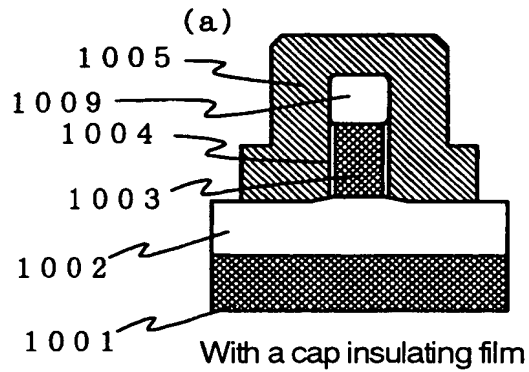


Fig. 24

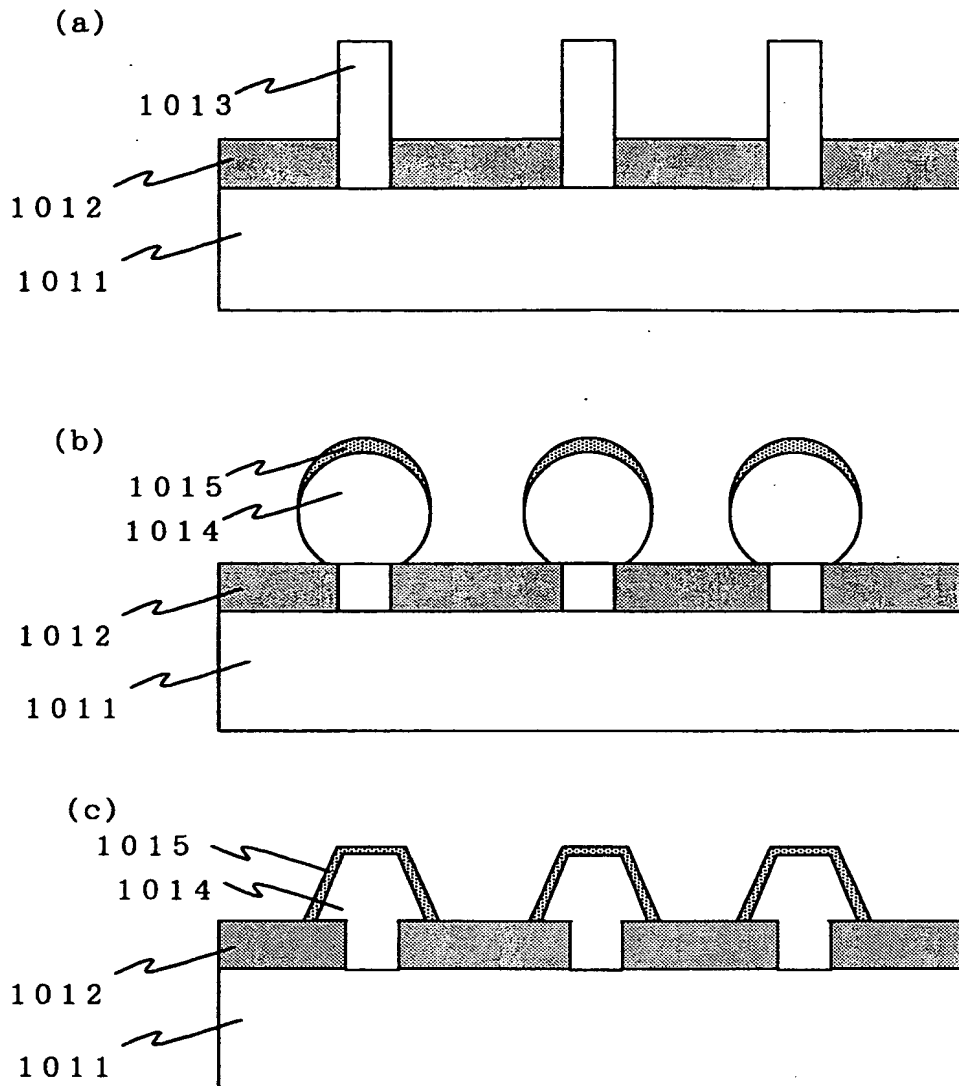


Fig. 25

